

SP1305 30pF, 30kV TVS Diode Array

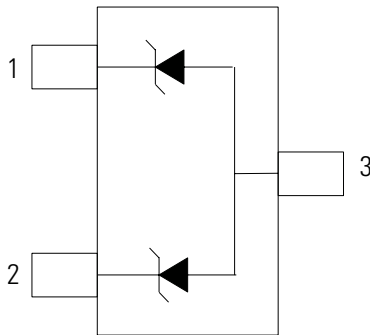


Description

The SP1305 TVS Diode Array is designed to protect sensitive equipment from damage due to electrostatic discharge (ESD), electrical fast transients (EFT), and lightning induced surges.

The SP1305 can absorb repetitive ESD strikes above the maximum level specified in the IEC 61000-4-2 international standard without performance degradation and safely dissipate up to 5A of 8/20µs induced surge current (IEC 61000-4-5, 2nd Edition) with very low clamping voltages.

Pinout and Functional Block Diagram



Features

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 50A (5/50ns)
- Lightning, IEC 61000-4-5 2nd Edition, 5A (8/20µs)
- Low clamping voltage
- Low leakage current
- Moisture Sensitivity Level (MSL-1)
- Halogen-Free, Lead-Free and RoHS-Compliant

Applications

- Industrial equipment
- Test and medical equipment
- Point-of-Sale terminals
- Motor controls
- Legacy ports (RS-232, RS-485)
- Security and alarm system

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Absolute Maximum Ratings

| Symbol | Parameter | Value | Units |
|------------|--|------------|-------|
| I_{PP} | Peak Pulse Current ($t_p=8/20\mu s$) | 5.0 | A |
| T_{OP} | Operating Temperature | -40 to 125 | °C |
| T_{STOR} | Storage Temperature | -55 to 150 | °C |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Characteristics ($T_{OP}=25^\circ C$)

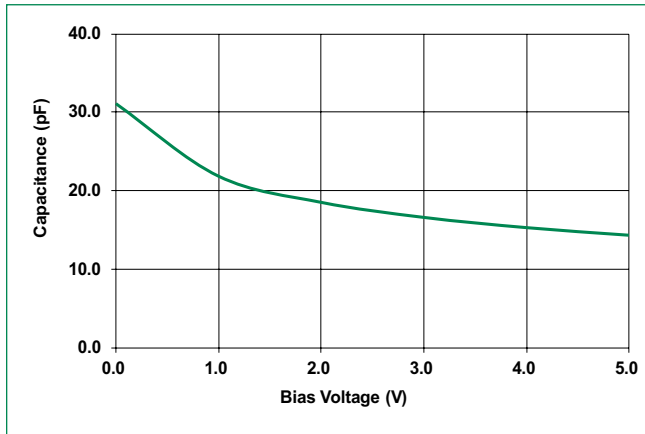
| Parameter | Symbol | Test Conditions | Min | Typ | Max | Units |
|------------------------------------|---------------|---|----------|------|------|----------|
| Reverse Standoff Voltage | V_{RWM} | $I_R=1\mu A$, Pin1 or Pin2 to Pin3 | | | 5 | V |
| Breakdown Voltage | V_{BR} | $I_R=1mA$, Pin1 or Pin2 to Pin3 | 6 | 7 | | V |
| Reverse Leakage Current | I_{LEAK} | $V_R=5V$ | | 0.1 | 0.5 | μA |
| Clamp Voltage ¹ | V_C | $I_{PP}=1A$, $t_p=8/20\mu s$, Pin1 or Pin2 to Pin3 | | 8.6 | 10 | V |
| | | $I_{PP}=5A$, $t_p=8/20\mu s$, Pin1 or Pin2 to Pin3 | | 11 | 13.5 | V |
| Dynamic Resistance ² | R_{DYN} | TLP, $t_p=100ns$, Pin1 or Pin2 to Pin3 | | 0.24 | | Ω |
| ESD Withstand Voltage ¹ | V_{ESD} | IEC 61000-4-2 (Contact Discharge) Pin1 or Pin2 to Pin3 | ± 30 | | | kV |
| | | IEC 61000-4-2 (Air Discharge) Pin1 or Pin2 to Pin3 | ± 30 | | | kV |
| Diode Capacitance ¹ | $C_{I/O-GND}$ | Reverse Bias=0V, $f=1MHz$; Pin1 or Pin2 to Pin3 | | 30 | 40 | pF |

Note:

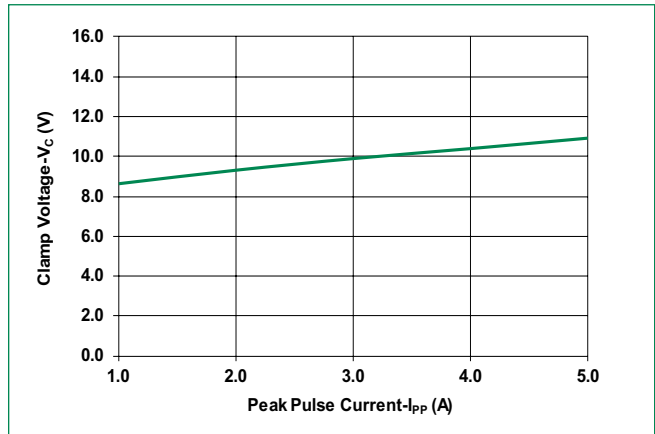
¹ Parameter is guaranteed by design and/or component characterization.

² Transmission Line Pulse (TLP) with 100ns width, 2ns rise time, and average window $t_1=70ns$ to $t_2=90ns$

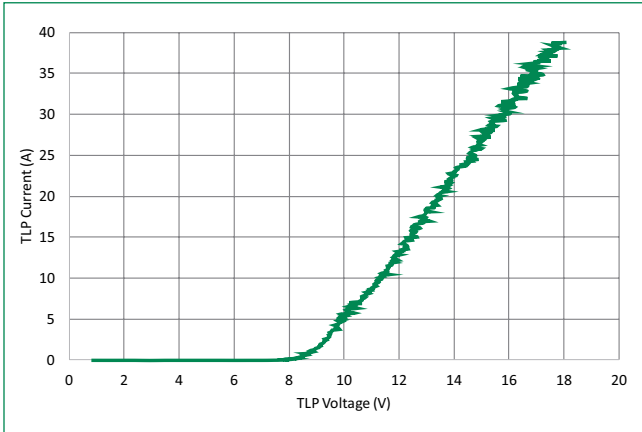
Capacitance vs. Reverse Bias (Pin1 or Pin2 to Pin3)



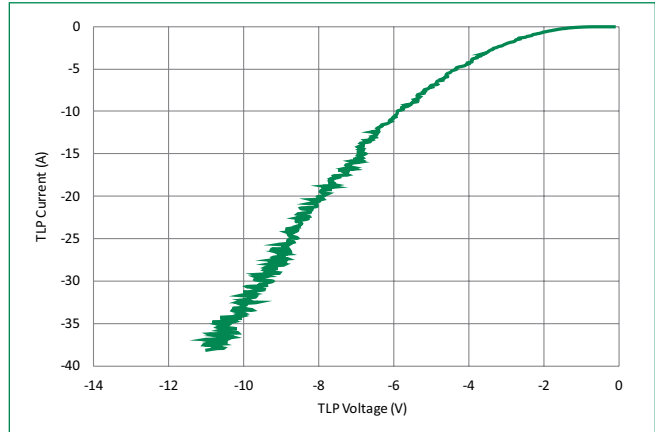
Clamping Voltage vs. Peak Pulse Current



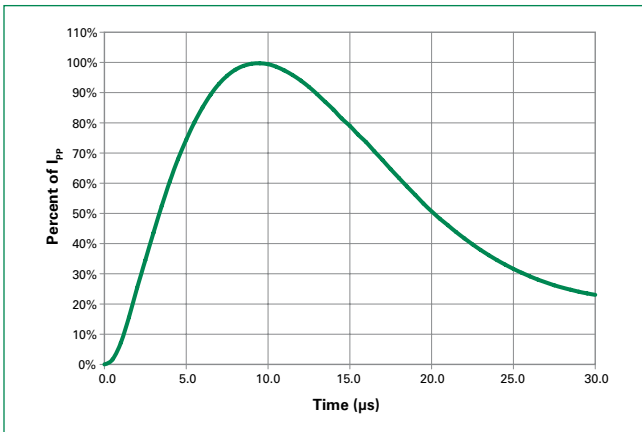
Positive Transmission Line Pulsing (TLP) Plot



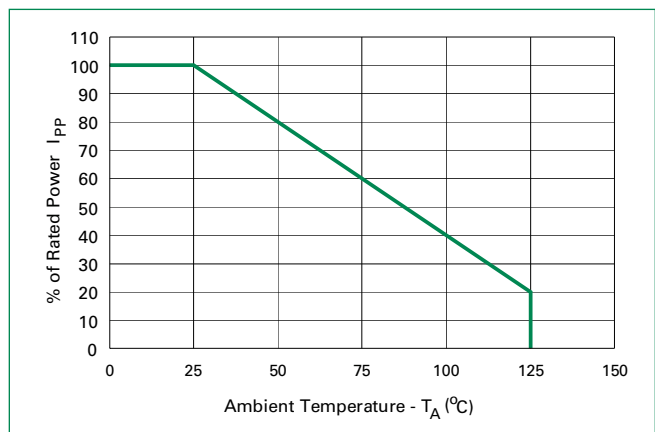
Negative Transmission Line Pulsing (TLP) Plot



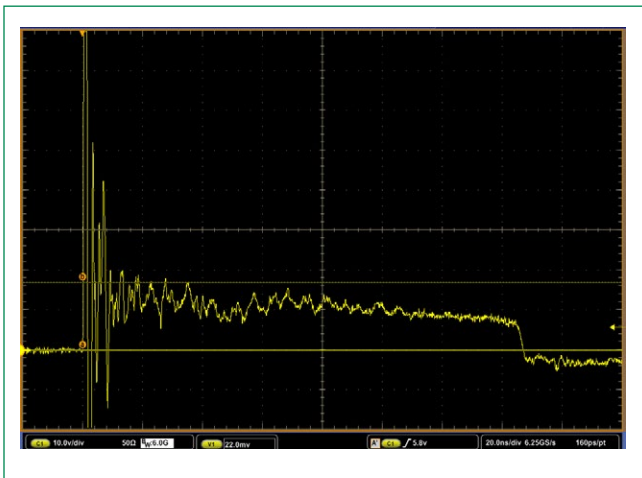
8/20µs Pulse Waveform



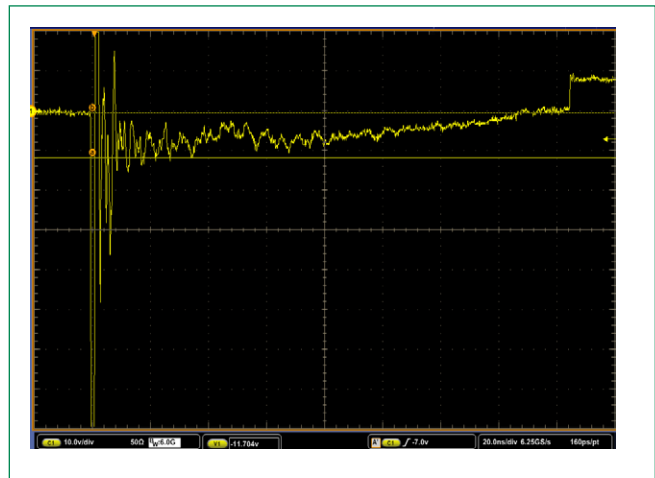
Power Derating Curve



IEC 61000-4-2 +8kV Contact ESD Clamping Voltage

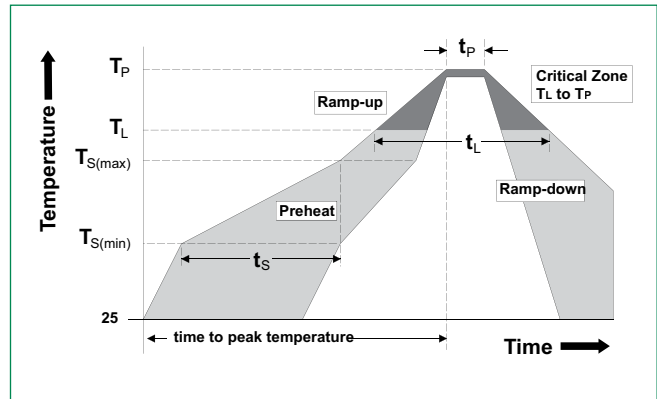


IEC 61000-4-2 -8kV Contact ESD Clamping Voltage



Soldering Parameters

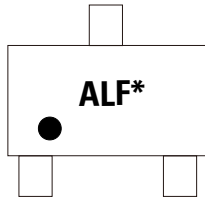
| | | |
|--|------------------------------------|-------------------------|
| Reflow Condition | | Pb – Free assembly |
| Pre Heat | - Temperature Min ($T_{s(min)}$) | 150°C |
| | - Temperature Max ($T_{s(max)}$) | 200°C |
| | - Time (min to max) (t_s) | 60 – 180 secs |
| Average ramp up rate (Liquidus) Temp (T_L) to peak | | 3°C/second max |
| $T_{s(max)}$ to T_L - Ramp-up Rate | | 3°C/second max |
| Reflow | - Temperature (T_L) (Liquidus) | 217°C |
| | - Temperature (t_L) | 60 – 150 seconds |
| Peak Temperature (T_p) | | 260 ^{+0/-5} °C |
| Time within 5°C of actual peak Temperature (t_p) | | 20 – 40 seconds |
| Ramp-down Rate | | 6°C/second max |
| Time 25°C to peak Temperature (T_p) | | 8 minutes Max. |
| Do not exceed | | 260°C |



Product Characteristics

| | |
|---------------------------|--|
| Lead Plating | Matte Tin |
| Lead Material | Copper Alloy |
| Lead Coplanarity | 0.004 inches(0.102mm) |
| Substrate Material | Silicon |
| Body Material | Molded Compound |
| Flammability | UL Recognized compound meeting flammability rating V-0 |

Part Marking System

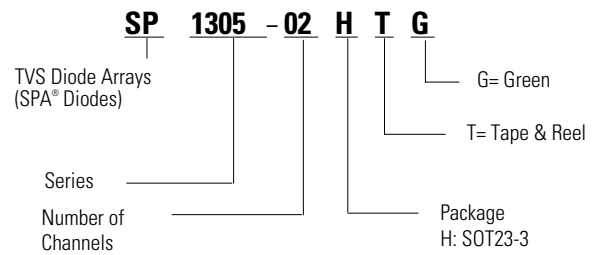


AL = Part code = SP1305-02HTG
F = Assembly site
* = Date code

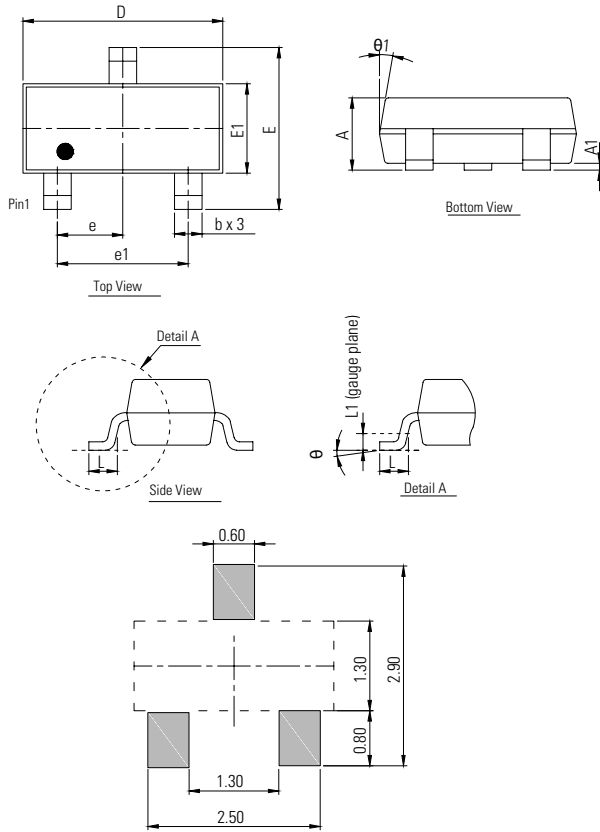
Ordering Information

| Part Number | Package | Min. Order Qty. |
|--------------|---------|-----------------|
| SP1305-02HTG | SOT23-3 | 3000 |

Part Numbering System

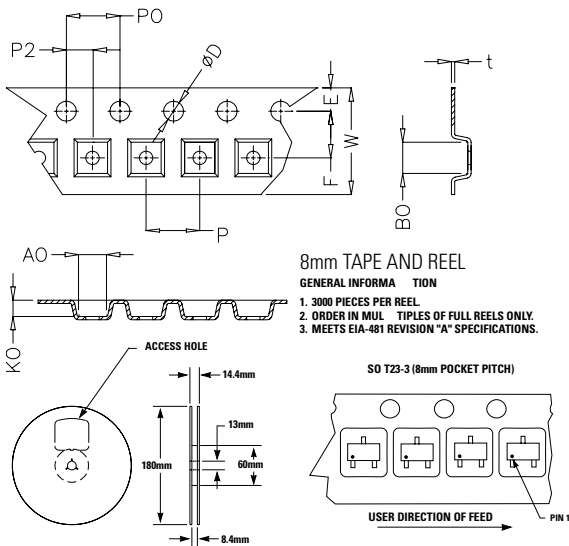


Package Dimensions — SOT23-3



| Package | SOT23-3 | | | | | |
|---------|-------------|------|------|-----------|-------|-------|
| Pins | 3 | | | | | |
| JEDEC | TO-236 | | | | | |
| Symbol | Millimeters | | | Inches | | |
| | Min | Nom | Max | Min | Nom | Max |
| A | 0.90 | 1.00 | 1.10 | 0.035 | 0.039 | 0.043 |
| A1 | 0.03 | - | 0.09 | 0.001 | - | 0.004 |
| b | 0.37 | 0.44 | 0.51 | 0.015 | 0.017 | 0.020 |
| D | 2.80 | 2.95 | 3.04 | 0.110 | 0.116 | 0.120 |
| E | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| E1 | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e | 0.95 BSC | | | 0.037 BSC | | |
| e1 | 1.90 BSC | | | 0.075 BSC | | |
| L | 0.30 | 0.45 | 0.55 | 0.012 | 0.018 | 0.022 |
| L1 | 0.25 BSC | | | 0.010 BSC | | |
| Θ | 0° | - | 8° | 0° | - | 8° |
| Θ1 | 7°TYP | | | 7°TYP | | |

Embossed Carrier Tape & Reel Specification — SOT23-3



| Symbol | Millimeters | | Inches | |
|--------|-------------|------|--------|-------|
| | Min | Max | Min | Max |
| E | 1.65 | 1.85 | 0.065 | 0.073 |
| F | 3.40 | 3.60 | 0.134 | 0.142 |
| P2 | 1.90 | 2.10 | 0.075 | 0.083 |
| D | 1.40 | 1.60 | 0.055 | 0.063 |
| P0 | 3.90 | 4.10 | 0.154 | 0.161 |
| W | 7.70 | 8.30 | 0.303 | 0.327 |
| P | 3.90 | 4.10 | 0.154 | 0.161 |
| A0 | 3.05 | 3.25 | 0.120 | 0.128 |
| B0 | 2.67 | 2.87 | 0.105 | 0.113 |
| K0 | 1.12 | 1.32 | 0.044 | 0.052 |
| t | 0.22 | 0.24 | 0.009 | 0.009 |